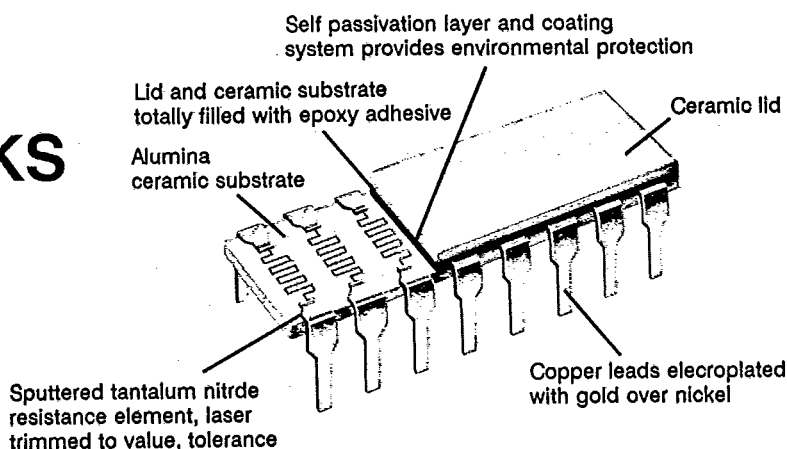




TANFILM DIP RESISTOR NETWORKS

- MIL qualified to both MIL-R-83401/01 and MIL-R-83401/02
- MIL spec qualified to .1% Tol, .02% available
- MIL spec qualified to 50 ppm/°C, 25 ppm/°C available
- Superior TCR tracking to 2 ppm/°C
- Ratios available to 0.01%
- Special mechanical and electrical configurations



TanFilm resistor networks are designed for use in applications requiring a high degree of reliability, stability, tight tolerance, close TCR tracking, and low noise. Our continuous feed, high vacuum sputtering process insures uniform properties from network to network. Precise state-of-the-art laser trimming enables us to easily zero in

the tightest ratios. Gold-plated copper leads are thermal pulse bonded to large-area gold conductor pads on the ceramic substrate assuring the most reliable termination and long-term stability. Passivated Tantalum Nitride resistor material offers performance far superior to military specifications and excellent environmental protection.

The versatile nature of our photo-etch process makes it readily adaptable to meet special customer requirements. Custom circuit designs and special mechanical configurations can be easily achieved with a modest set up charge. Full military screening is also available with all units.

SPECIFICATIONS:

MIL Qualified Resistance Values:
Schematic A: 100Ω to 100KΩ
Schematic B: 100Ω to 70KΩ
Higher and lower resistance values available

Std Resistance Tolerances:
.1%, .25%, .5%, 1%, 2%,
.02% available

Temperature Coefficient of Resistance:
±25 ppm/°C, ±50 ppm/°C,
±100 ppm/°C, ±300 ppm/°C

TCR Tracking: 5 ppm/°C, except
Models 1987 & 1998 below 500Ω
(20 ppm/°C); 2 ppm/°C
Temperature Range:
-55°C to +150°C
Power Rating @ 70°C:

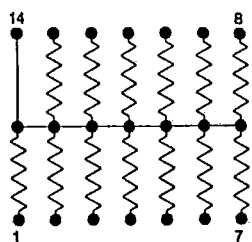
Model	Wattage	
	Resistor	Network
1987	.1	1.3
1998	.1	1.5
1989	.2	1.4
1999	.2	1.6

Noise: Less than -30 dB
Lead Material: Gold plated copper
Substrate Material: 99.5% pure alumina ceramic
Construction: Ceramic sandwich epoxy encapsulant

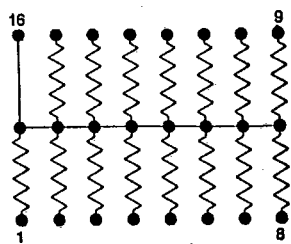
Custom Circuit and Special Testing Available

Contact factory for any special features required

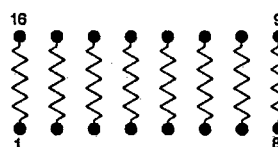
STANDARD CIRCUITS:



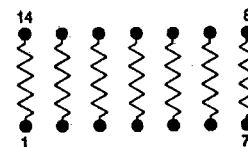
Schematic B



Schematic B



Schematic A



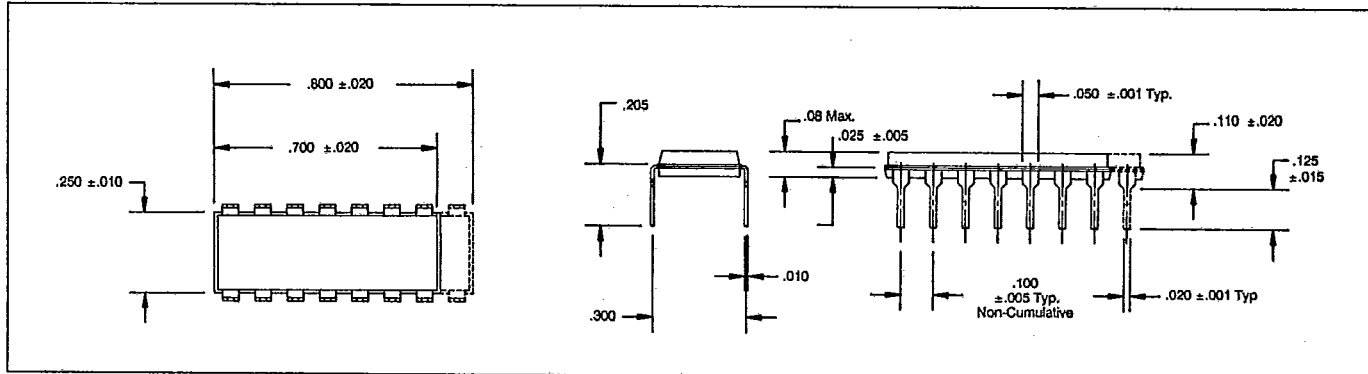
Schematic A



TANFILM DIP PERFORMANCE DATA:

Test Per MIL-R-83401	MIL-R-83401 Limits ($\Delta R\%$)			TanFilm Test Data ($\Delta R\%$)	
	M	K	H	Maximum	Typical
Thermal Shock and Power Conditioning	0.70	.70	.50	.10	.02
Low Temperature Operation	0.50	.25	.10	.10	.02
Short Time Overload	0.50	.25	.10	.05	.02
Terminal Strength	0.25	.25	.25	.10	.02
Resistance to Soldering Heat	0.25	.25	.10	.10	.02
Moisture Resistance	0.50	.50	.40	.10	.02
Shock	0.25	.25	.25	.10	.02
Vibration	0.25	.25	.25	.10	.02
Life	2.00	.50	.50	.10	.02
High Temperature Exposure	1.00	.50	.20	.10	.02
Low Temperature Storage	0.50	.25	.10	.10	.02
25°C Double Load	2.00	.50	.50	.05	.02

DIMENSIONS - INCHES:



HOW TO ORDER

Sample Part No.

Model

1999

Characteristic

06

Resistance

1001

Absolute
Tolerance Code

B

Ratio Tolerance
to R₁
(if specified)1989 7-resistor 14 Pin DIP,
straight thru (MIL-R-83401-01, schematic A)1999 8-resistor 16 Pin DIP,
straight thru (MIL-R-83401-02, schematic A)1987 13-resistor, 14 Pin DIP,
one common lead (MIL-R-83401-01, schematic B)1998 15-resistor, 16 Pin DIP,
one common lead (MIL-R-83401-02, schematic B)Characteristic

Code	Classification	TCR (ppm/°C)
01	Commercial Grade	±100
02	Commercial Grade	±50
03	Commercial Grade	±25
04	Military Screening	±300
05	Military Screening	±100
06	Military Screening	±50
07	Military Screening	±25

Resistance Absolute/Ratio
Tolerance CodeStandard MIL
resistance codeExample:
1001 = 1000ΩStandard MIL
tolerance code

A ±.05%
 B ±.1%
 C ±.25%
 D ±.50%
 F ±1.0%
 G ±2.0%
 T ±.01%
 Q ±.02%